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Receipt

PATENT
Attorney Docket No. 214598

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application of:

Verschueren et al.

Application No. 10/016,960

Filed: December 7, 2001

For: METHOD OF LITHOGRAPHIC PRINTING
WITH A REUSABLE SUBSTRATE

4 / CFR
E. Willis
4 - 17 - 02

Group Art Unit: 2853

Examiner: Unassigned

REQUEST FOR CORRECTED FILING RECEIPT

Commissioner for Patents
Washington, D.C. 20231

Dear Sir:

Applicants respectfully request that a corrected version of the filing receipt (copy enclosed, with requested changes marked in red) be issued for the above-identified application.

Particularly, applicants request that the cities of residence of the inventors be corrected. The correct city of residence for Eric Verschueren is Merksplas, Belgium. The correct city of residence for Joan Vermeersch is Deinze, Belgium. Copies of the Declaration and Application Data Sheet, as filed with the application papers on December 7, 2001, are enclosed. Each indicates the correct city of residence for each inventor.

Respectfully submitted,

By
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Date: February 21, 2002

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In re Appln. of Verschueren et al.
Application No. 10/016,960



CERTIFICATE OF MAILING

I hereby certify that this REQUEST FOR CORRECTED FILING RECEIPT (along with any documents referred to as being attached or enclosed) is being deposited with the United States Postal Service on the date shown below with sufficient postage as first class mail in an envelope addressed to: Commissioner for Patents, Washington, D.C. 20231.

Date: 2/21/02

Virginia Scheifele

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APPLICATION NUMBER	FILING DATE	GRP ART UNIT	FIL FEE REC'D	ATTY.DOCKET.NO	DRAWINGS	TOT CLAIMS	IND CLAIMS
10/016,960	12/07/2001	2853	740	214598		7	1

CONFIRMATION NO. 7343

23460
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FILING RECEIPT



OC00000007349437

Date Mailed: 01/23/2002

Receipt is acknowledged of this nonprovisional Patent Application. It will be considered in its order and you will be notified as to the results of the examination. Be sure to provide the U.S. APPLICATION NUMBER, FILING DATE, NAME OF APPLICANT, and TITLE OF INVENTION when inquiring about this application. Fees transmitted by check or draft are subject to collection. Please verify the accuracy of the data presented on this receipt. If an error is noted on this Filing Receipt, please write to the Office of Initial Patent Examination's Customer Service Center. Please provide a copy of this Filing Receipt with the changes noted thereon. If you received a "Notice to File Missing Parts" for this application, please submit any corrections to this Filing Receipt with your reply to the Notice. When the USPTO processes the reply to the Notice, the USPTO will generate another Filing Receipt incorporating the requested corrections (if appropriate).

Applicant(s) *Merkspas*
Eric Verschueren, Mortsel, BELGIUM;
Joan Vermeersch, Mortsel, BELGIUM;
Deinze

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Assignment For Published Patent Application
Agfa-Gevaert, Mortsel, BELGIUM;

JAN 29 2002

Domestic Priority data as claimed by applicant

PAT/TM Due Date

THIS APPLN CLAIMS BENEFIT OF 60/259,483 01/03/2001

noted
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Foreign Applications

EUROPEAN PATENT OFFICE (EPO) 00204376.8 12/07/2000

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If Required, Foreign Filing License Granted 01/23/2002

Projected Publication Date: 06/13/2002

Non-Publication Request: No

Early Publication Request: No

Title

Method of lithographic printing with a reusable substrate

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